

## OptiMOS™-T Power-Transistor

# AEC® © Qualified



### **Product Summary**

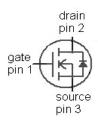
$V_{\mathrm{DS}}$	120	V
R <sub>DS(on),max</sub> (SMD version)	11.3	mΩ
$I_{D}$	70	Α

### **Features**

- OptiMOS<sup>TM</sup> power MOSFET for automotive applications
- N-channel Enhancement mode
- Automotive AEC Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

_	PG-TO263-3-2	PG-TO262-3-1	PG-TO220-3-1
	2 (tab)	123	

Туре	Package	Marking
IPB70N12S3-11	PG-TO263-3-2	3N1211
IPI70N12S3-11	PG-TO262-3-1	3N1211
IPP70N12S3-11	PG-TO220-3-1	3N1211



### **Maximum ratings,** at $T_i$ =25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	T <sub>C</sub> =25 °C, V <sub>GS</sub> =10 V	70	А
		T <sub>C</sub> =100 °C, V <sub>GS</sub> =10 V <sup>1)</sup>	48	
Pulsed drain current <sup>1)</sup>	I <sub>D,pulse</sub>	T <sub>C</sub> =25 °C	280	
Avalanche energy, single pulse <sup>1)</sup>	E <sub>AS</sub>	I <sub>D</sub> =35A	410	mJ
Avalanche current, single pulse	IAS	-	70	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> =25 °C	125	W
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-	-55 +175	°C

# IPB70N12S3-11 IPI70N12S3-11, IPP70N12S3-11

Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	
Thermal characteristics <sup>1)</sup>						
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	-	1.2	K/W
Thermal resistance, junction - ambient, leaded	R <sub>thJA</sub>	-	-	-	62	
SMD version, device on PCB	R <sub>thJA</sub>	minimal footprint	-	-	62	
		6 cm <sup>2</sup> cooling area <sup>2)</sup>	-	-	40	

# **Electrical characteristics,** at $T_{\rm j}$ =25 °C, unless otherwise specified

### **Static characteristics**

Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0 V, I <sub>D</sub> = 1 mA	120	-	-	V
Gate threshold voltage	$V_{\rm GS(th)}$	$V_{\rm DS}=V_{\rm GS}, I_{\rm D}=83\mu{\rm A}$	2.0	3.0	4.0	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =120V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =25°C	-	0.01	0.1	μA
		$V_{\rm DS}$ =120V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =125°C <sup>1)</sup>	-	1	10	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =70A	-	9.7	11.6	$m\Omega$
		V <sub>GS</sub> =10V, I <sub>D</sub> =70A, SMD version	-	9.4	11.3	



Parameter	Symbol	Conditions	Values		S Un	
			min.	typ.	max.	
Dynamic characteristics <sup>1)</sup>						
Input capacitance	C iss		-	3350	4355	pF
Output capacitance	Coss	$V_{\rm GS}$ =0V, $V_{\rm DS}$ =25V, $f$ =1MHz	-	940	1222	1
Reverse transfer capacitance	C <sub>rss</sub>		-	105	158	
Turn-on delay time	t <sub>d(on)</sub>		-	17	-	ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> =20 V, V <sub>GS</sub> =10 V,	-	8	-	1
Turn-off delay time	t <sub>d(off)</sub>	$I_D$ =70 A, $R_G$ =3.5 Ω	-	25	-	
Fall time	t <sub>f</sub>		-	8	-	
Gate Charge Characteristics <sup>1)</sup>						
Gate to source charge	Q <sub>gs</sub>		-	18	23	nC
Gate to drain charge	Q <sub>gd</sub>	V <sub>DD</sub> =96 V, I <sub>D</sub> =70 A,	-	16	24	
Gate charge total	Q <sub>g</sub>	V <sub>GS</sub> =0 to 10 V	-	51	65	
Gate plateau voltage	V <sub>plateau</sub>		-	5.5	-	V
Reverse Diode					-	
Diode continous forward current <sup>1)</sup>	Is	T -25°C	-	-	70	А
Diode pulse current <sup>1)</sup>	I <sub>S,pulse</sub>	- T <sub>C</sub> =25°C	-	-	280	1
Diode forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0 V, I <sub>F</sub> =70 A, T <sub>j</sub> =25 °C	0.6	1	1.2	V
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	$V_R$ =60V, $I_F$ =50A, $di_F/dt$ =100A/ $\mu$ s	-	100	-	ns
Reverse recovery charge <sup>1)</sup>	Q <sub>rr</sub>		-	265	-	nC

<sup>1)</sup> Defined by design. Not subject to production test.

 $<sup>^{2)}</sup>$  Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.



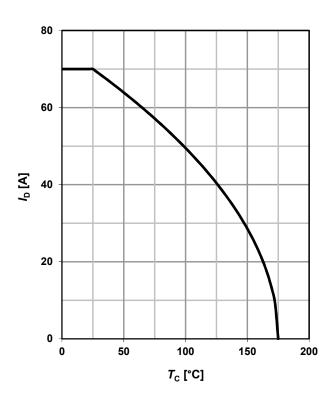
### 1 Power dissipation

$$P_{\text{tot}} = f(T_{\text{C}}); V_{\text{GS}} = 10 \text{ V}$$

# 150 125 100 25 50 25 0 0 0 50 100 150 200 T<sub>C</sub> [°C]

### 2 Drain current

$$I_D = f(T_C)$$
;  $V_{GS} = 10 \text{ V}$ ; SMD



### 3 Safe operating area

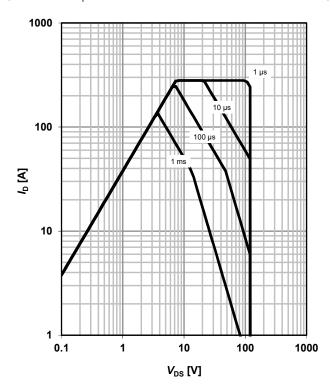
$$I_D = f(V_{DS}); T_C = 25 \text{ °C}; D = 0; \text{SMD}$$

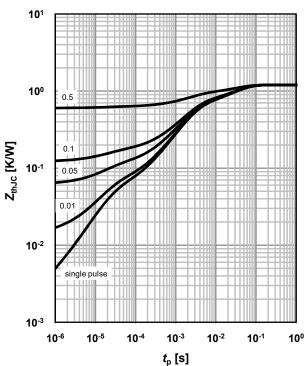
parameter: t<sub>p</sub>

### 4 Max. transient thermal impedance

$$Z_{thJC} = f(t_p)$$

parameter:  $D = t_p/T$ 



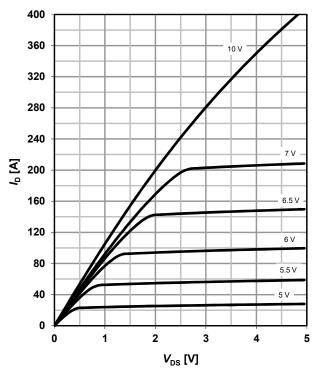




### 5 Typ. output characteristics

 $I_D = f(V_{DS}); T_i = 25 \text{ °C}; SMD$ 

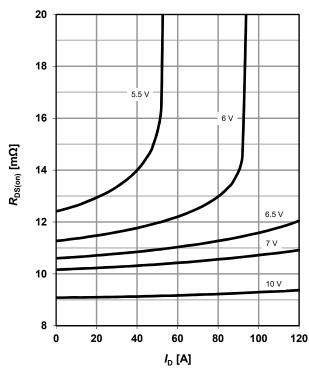
parameter:  $V_{\rm GS}$ 



### 6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25 °C; SMD$ 

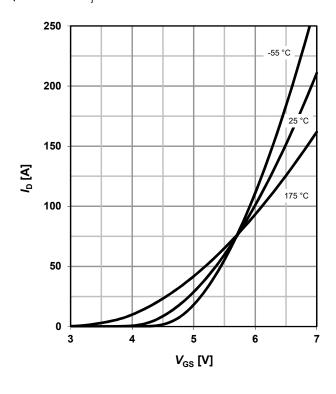
parameter: V<sub>GS</sub>



### 7 Typ. transfer characteristics

 $I_D = f(V_{GS}); V_{DS} = 6V$ 

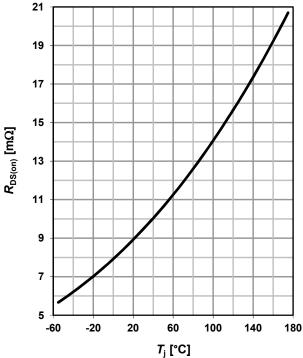
parameter: T<sub>i</sub>



### 8 Typ. drain-source on-state resistance

 $R_{DS(on)}$  = f( $T_j$ );  $I_D$  = 70 A;  $V_{GS}$  = 10 V; SMD

 $\alpha = 0.4$ 





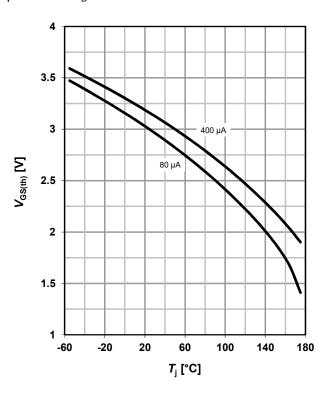
### 9 Typ. gate threshold voltage

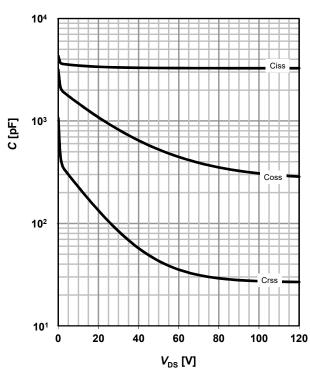
 $V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$ 

parameter:  $I_D$ 

### 10 Typ. capacitances

$$C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$$

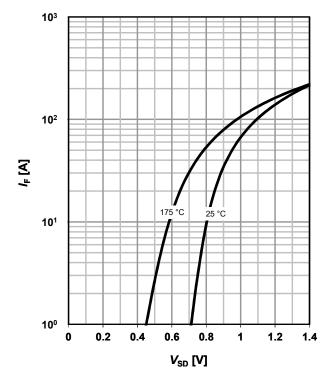




### 11 Typical forward diode characteristics

 $I_{\rm F} = f(V_{\rm SD})$ 

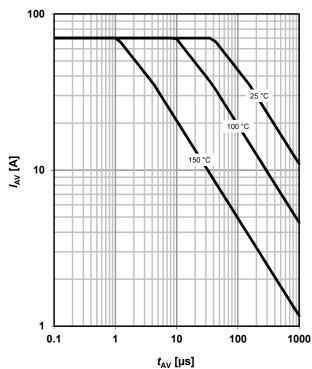
parameter:  $T_{\rm j}$ 



### 12 Typ. avalanche characteristics

 $I_{AS} = f(t_{AV})$ 

parameter:  $T_{j(start)}$ 





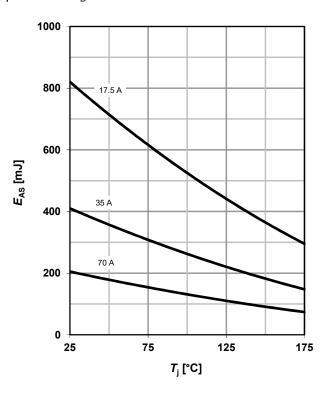
### 13 Typical avalanche energy

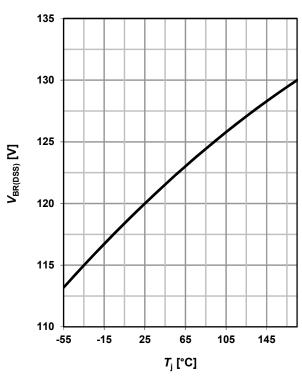
### $E_{AS} = f(T_i)$

parameter: I<sub>D</sub>

### 14 Typ. drain-source breakdown voltage

$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$

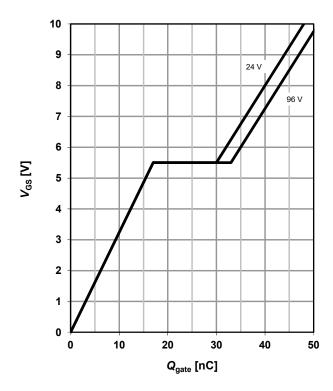




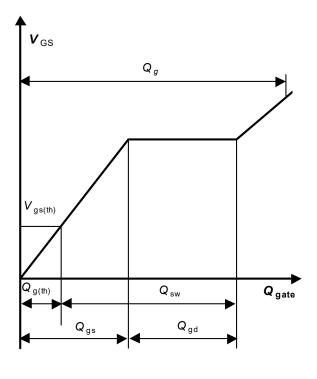
# 15 Typ. gate charge

 $V_{GS} = f(Q_{gate}); I_D = 70 A pulsed$ 

parameter:  $V_{\rm DD}$ 



### 16 Gate charge waveforms





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### **Revision History**

Version	Date	Changes
Revision 1.0	2016-06-20	Final Data Sheet
Revision 1.1	2023-06-15	Diagram 8 Typ. drain-source on- state resistance: used α value clarified
Revision 1.1	2023-06-15	Corrected diagram 10 typical capacitances